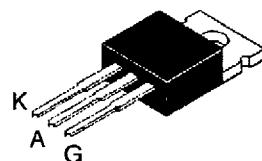


SCR
FEATURES

- $I_{T(RMS)} = 8A$
- $V_{DRM} = 200V$ to $800V$
- High surge current capability


**TO220
non-insulated
(Plastic)**
DESCRIPTION

The S08xxxH series of SCRs uses a high performance MESA GLASS PNPN technology. These parts are intended for general purpose applications.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
$I_{T(RMS)}$	RMS on-state current (180° conduction angle)	8	A
$I_{T(AV)}$	Average on-state current (180° conduction angle)	5.1	A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = 25°C)	$t_p = 8.3$ ms	88
		$t_p = 10$ ms	80
I^2t	I^2t Value for fusing	32	A^2s
dI/dt	Critical rate of rise of on-state current $I_G = 100$ mA $dI/dt = 1$ A/ μ s.	100	A/μ s
T_{stg} T_j	Storage and operating junction temperature range	- 40, + 150 - 40, + 125	°C
T_I	Maximum lead temperature for soldering during 10s at 4.5mm from case	260	°C

Symbol	Parameter	Voltage				Unit
		B	D	M	N	
V_{DRM} V_{RRM}	Repetitive peak off-state voltage $T_j = 125^\circ C$	200	400	600	800	V

S08xxxH

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient	60	°C/W
R _{th(j-c)}	Junction to case for DC	4	°C/W

GATE CHARACTERISTICS (maximum values)

P_{G(AV)} = 1 W P_{GM} = 10 W (t_p = 20 µs) I_{GM} = 4 A (t_p = 20 µs)

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Sensitivity			Unit	
			06	10	17		
I _{GT}	V _D =12V (DC) R _L =33Ω	T _j = 25°C	MIN	0.5	10	4	mA
			MAX	5	25	15	
V _{GT}	V _D =12V (DC) R _L =33Ω	T _j = 25°C	MAX	1.5		V	
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ	T _j = 125°C	MIN	0.2		V	
t _{GT}	V _D =V _{DRM} I _{TM} = 3 x I _{T(AV)} dI _G /dt = 0.5A/µs I _G = 40mA	T _j = 25°C	TYP	2		µs	
I _H	I _T = 250mA Gate open	T _j = 25°C	MAX	25	75	50	mA
I _L	I _G =1.2 I _{GT}	T _j = 25°C	MAX	50	150	100	mA
V _{TM}	I _{TM} = 16A t _p = 380µs	T _j = 25°C	MAX	1.6		V	
I _{DRM} I _{RRM}	V _D = V _{DRM} V _R = V _{RRM}	T _j = 25°C	MAX	5		µA	
		T _j = 110°C	MAX	500			
dV/dt	V _D =67%V _{DRM} Gate open	T _j = 110°C	MIN		200	100	V/µs
		T _j = 110°C	TYP	50			
t _q	I _{TM} = 3 x I _{T(AV)} V _R =35V dI/dt=10A/µs t _p =100µs dV/dt=10V/µs V _D = 67%V _{DRM}	T _j = 110°C	MAX	100		µs	

ORDERING INFORMATION

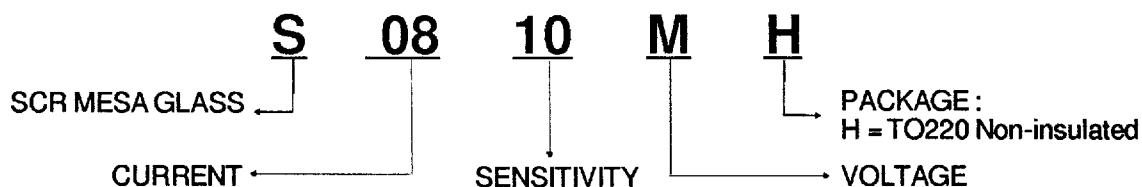


Fig.1 : Maximum average power dissipation versus average on-state current.

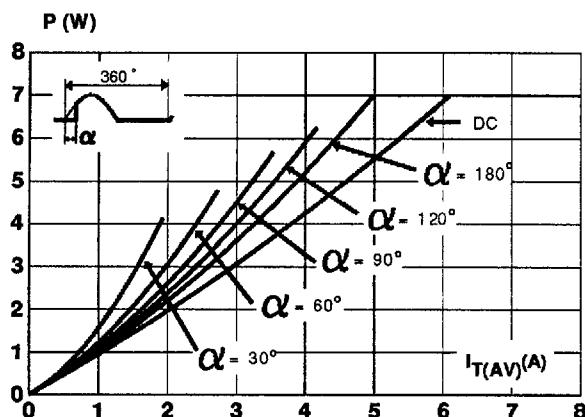


Fig.2 : Correlation between maximum average power dissipation and maximum allowable temperature (Tamb and Tcase) for different thermal resistances heatsink + contact.

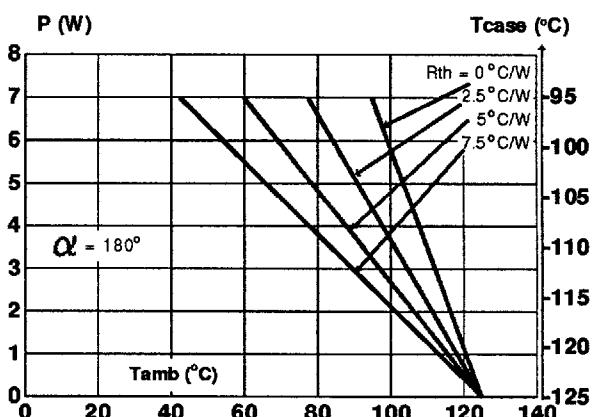


Fig.3 : Average on-state current versus case temperature.

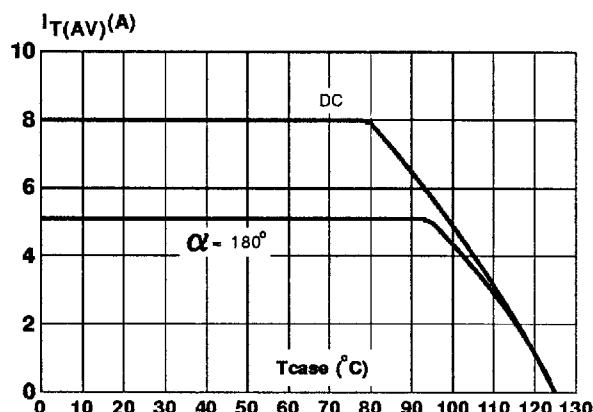


Fig.4 : Relative variation of thermal impedance versus pulse duration.

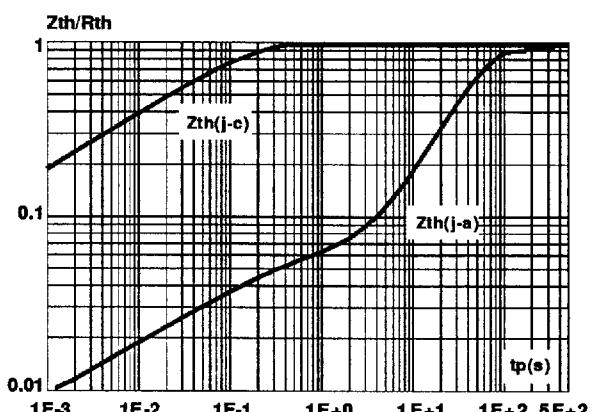


Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

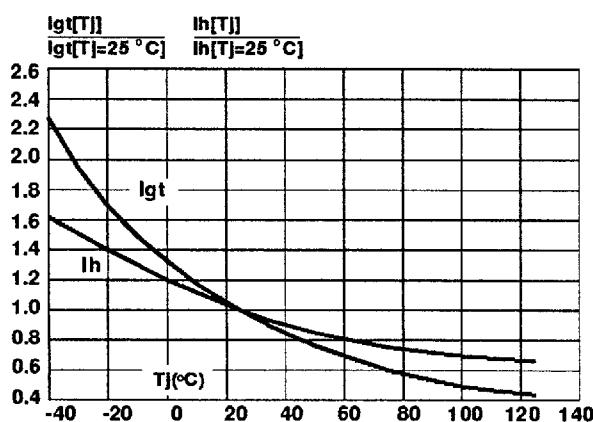
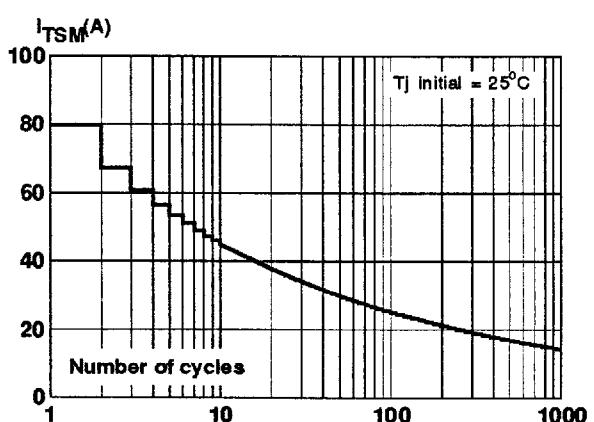


Fig.6 : Non repetitive surge peak on-state current versus number of cycles.



S08xxxH

Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t_p \leq 10\text{ms}$, and corresponding value of I^2t .

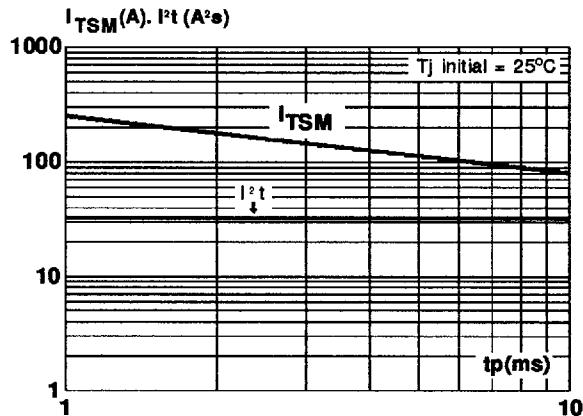
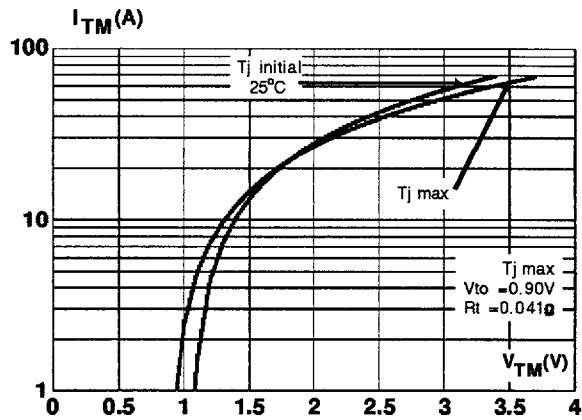
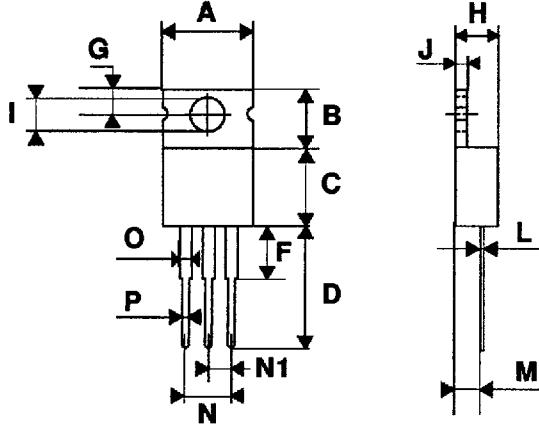


Fig.8 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA
TO220 Non-insulated (Plastic)



REF.	DIMENSIONS					
	Millimeters			Inches		
	Typ.	Min.	Max.	Typ.	Min.	Max.
A			10.3			0.406
B		6.3	6.5	0.248	0.256	
C			9.1			0.358
D		12.7			0.500	
F			4.2			0.165
G			3.0			0.118
H		4.5	4.7		0.177	0.185
I		3.53	3.66		0.139	0.144
J		1.2	1.3		0.047	0.051
L			0.9			0.035
M	2.7			0.106		
N			5.3			0.209
N1	2.54			0.100		
O		1.2	1.4		0.047	0.055
P			1.15			0.045

Marking : type number

Weight : 1.8 g

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